**Bill Of Materials**

**TI Designs # TDA-0083**

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<th>Description</th>
<th>PartNumber</th>
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<th>RoHS</th>
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**Description**

- **Sl. No.**
- **Fitted**
- **Quantity**
- **Designator**
- **Description**
- **PartNumber**
- **Manufacturer**
- **RoHS**
- **Package/Reference**

**Additional Details**

- **Bill Of Materials**
- **TI Designs # TDA-0083**
- **Negative Linear Regulator**
- **10,000 per roll**
- **Pb-Free**
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